

03-07-01

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EXPRESS MAIL NO. EL7197 4US

Docket No. 85A 3050
Date: March 6, 2001IN THE UNITED STATES PATENT AND TRADEMARK OFFICEAssistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

Transmitted herewith for filing is the patent application for inventor(s):

SHIGERU HAYATA, RYUICHI KYOMASU, SATOSHI ENOKIDO and TOSHIKI SASANO

For: OFFSET MEASUREMENT METHOD, TOOL POSITION DETECTION METHOD AND
BONDING APPARATUS

Also enclosed are:

- ☒ 13 sheets of drawings
- ☒ Certified copy of Japanese Patent Application No. 2000-059843 of March 6, 2000 on which Convention priority is claimed
- ☒ Declaration and Power of Attorney
- ☒ Information Disclosure Statement by Applicant
- ☐ Preliminary Amendment
- ☒ An assignment of the invention to KABUSHIKI KAISHA SHINKAWA

☒ Applicant claims Small Entity Status

CALCULATION OF FEES									
ITEM		TOTAL NO. OF CLAIMS		NO. OF CLAIMS OVER BASE	LG/SM \$ ENTITY FEE		\$ AMOUNT	\$ FEE	
A	TOTAL CLAIMS FEE	14	-20	0	LG=\$18 SM=\$9	\$9	\$ 0		
B	INDEPENDENT CLAIMS FEE*	4	-3	1	LG=\$80 SM=\$40	\$40	\$ 40		
C	SUBTOTAL - ADDITIONAL CLAIMS FEE (ADD FINAL COLUMN IN LINES A + B)							\$	40
D	MULTIPLE-DEPENDENT CLAIMS FEE					LARGE ENTITY FEE = \$270 SMALL ENTITY FEE = \$135		\$	0
E	BASIC FEE					LARGE ENTITY FEE = \$710 SMALL ENTITY FEE = \$355		\$	355
F	TOTAL FILING FEE (ADD TOTALS FOR LINES C, D, AND E)							\$	395
G	ASSIGNMENT RECORDING FEE						\$ 40	\$	40
	*LIST INDEPENDENT CLAIMS 1, 7, 13, 14								

- ☒ The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Account No. 11-1445. A duplicate copy of this sheet is enclosed.
- ☒ A check in the amount of \$ 395 to cover the filing fee is enclosed.
- ☒ A check in the amount of \$ 40 to cover Assignment Recordation fee is enclosed.

Respectfully submitted,
KODA & ANDROLIA

By:

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OFFSET MEASUREMENT METHOD, TOOL POSITION DETECTION METHOD AND BONDING APPARATUS